

Amended CLAIMS under PCT article 19

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1. (Amended) A module component comprising:
a substrate made of resin having a penetration hole;
a circuit wiring disposed on both sides of said substrate; and
a chip component having a height almost same as a depth of said
penetration hole and put in the penetration hole for electrically coupling
said circuit wiring disposed on both sides of said substrate,
wherein the penetration hole is formed at a position according to a matrix,
10 and
wherein a chip component having a specific value is accommodated to
compose a desired circuit.

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2. (Deleted)

3. (Amended) A module component according to claim 1, wherein
the penetration holes are formed according to a matrix, and said chip
component having the specific value is put in a specified penetration hole.

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